

Vishay Siliconix

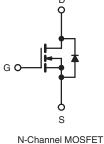
RoHS

COMPLIANT

Power MOSFET

PRODUCT SUMMARY				
V_{DS} at T_J max. (V)	650			
R _{DS(on)} (Ω)	$V_{GS} = 10 V$	0.190		
Q _g (Max.) (nC)	98			
Q _{gs} (nC)	17			
Q _{gd} (nC)	25			
Configuration	Single			





FEATURES

- High E_{AR} Capability
- Lower Figure-of-Merit Ron x Qg
- 100 % Avalanche Tested
- High Peak Current Capability
- dV/dt Ruggedness
- Effective Coss Specified
- Improved Transconductance
- Improved t_{rr}/Q_{rr}
- Improved Gate Charge
- High Power Dissipation Capability
- Compliant to RoHS Directive 2002/95/EC

ORDERING INFORMATION			
Package	TO-220 FULLPAK		
Lead (Pb)-free	SiHF22N60S-E3		

ABSOLUTE MAXIMUM RATINGS ($T_C = 25 \degree C$, unless otherwise noted)							
PARAMETER			SYMBOL	LIMIT	UNIT		
Drain-Source Voltage			V _{DS}	600	v		
Gate-Source Voltage			V _{GS}	± 20]		
Continuous Drain Current ^a	Vec at 10 V	T _C = 25 °C T _C = 100 °C	- I _D -	22			
	VGS at 10 V	T _C = 100 °C		13	А		
Pulsed Drain Current ^b			I _{DM}	65			
Linear Derating Factor				2	W/°C		
Single Pulse Avalanche Energy ^c			E _{AS}	690	- mJ		
epetitive Avalanche Energy ^b			E _{AR}	25			
Maximum Power Dissipation			P _D	250	W		
Peak Diode Recovery dV/dt ^d			dV/dt	7.3	V/ns		
Operating Junction and Storage Temperature Range			T _J , T _{stg}	- 55 to + 150	*0		
Soldering Recommendations (Peak Temperature) ^e	for	10 s	-	300	- °C		

Notes

a. Limited by maximum junction temperature.

b. Repetitive rating; pulse width limited by maximum junction temperature.

- c. V_{DD} = 50 V, starting T_J = 25 °C, L = 28.2 mH, R_g = 25 $\Omega,$ I_{AS} = 7 A.
- d. $I_{SD} \le 22$ A, dl/dt ≤ 340 A/µs, $V_{DD} \le V_{DS}$, $T_J \le 150$ °C.

e. 1.6 mm from case.

* Pb containing terminations are not RoHS compliant, exemptions may apply

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THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum Junction-to-Ambient	R _{thJA}	-	65	°C/W	
Maximum Junction-to-Case (Drain)	R _{thJC}	-	3.4	C/ W	

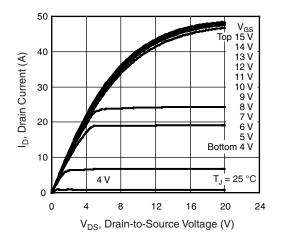
PARAMETER	SYMBOL	TES	MIN.	TYP.	MAX.	UNIT	
Static		•		•	•		
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 V, I_D = 1 mA$		600	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference to 25 °C, I _D = 1 mA		-	0.70	-	V/°C
Gate-Source Threshold Voltage (N)	V _{GS(th)}	V _{DS} =	V _{GS} , I _D = 250 μA	2.0	-	4.0	V
Gate-Source Leakage	I _{GSS}	$V_{GS} = \pm 20 V$		-	-	± 100	nA
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 600 \text{ V}, V_{GS} = 0 \text{ V}$ $V_{DS} = 600 \text{ V}, V_{GS} = 0 \text{ V}, T_J = 150 \text{ °C}$		-	-	5 100	μA
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V	$I_{\rm D} = 22 \text{ A}$	-	0.160	0.190	Ω
Forward Transconductance ^a	9 _{fs}	$V_{DS} = 50 \text{ V}, \text{ I}_{D} = 13 \text{ A}$		-	9.4	-	S
Dynamic		1		1	I	I	1
Input Capacitance	C _{iss}	V _{GS} = 0 V, V _{DS} = 25 V, f = 1.0 MHz		-	2810	-	pF
Output Capacitance	C _{oss}			-	1480	-	
Reverse Transfer Capacitance	C _{rss}			-	33	-	
Effective Output Capacitance (Time Related)	C _{oss eff.} (TR) ^a	V _{GS} = 0 V	$V_{DS} = 0 V$ to 480 V	-	155	-	
Total Gate Charge	Qg		/ I _D = 22 A, V _{DS} = 480 V	-	75	-	
Gate-Source Charge	Q _{gs}	V _{GS} = 10 V		-	17	-	nC
Gate-Drain Charge	Q _{gd}			-	25	-	
Turn-On Delay Time	t _{d(on)}		•	-	24	-	1
Rise Time	t _r	$\begin{array}{l} V_{\text{DD}}=380 \text{ V}, \ I_{\text{D}}=22 \text{ A}, \\ R_{g}=9.1 \ \Omega, \ V_{\text{GS}}=10 \text{ V} \end{array}$		-	68	-	- ns
Turn-Off Delay Time	t _{d(off)}			-	77	-	
Fall Time	t _f			-	59	-	
Gate Input Resistance	R _g	f = 1 MHz, open drain		-	0.65	-	Ω
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	22	•
Pulsed Diode Forward Current	I _{SM}			-	-	88	A
Diode Forward Voltage	V _{SD}	$T_J = 25 \text{ °C}, I_S = 22 \text{ A}, V_{GS} = 0 \text{ V}$		-	-	1.2	V
Reverse Recovery Time	t _{rr}	T _J = 25 °C, I _F = I _S , dl/dt = 100 A/µs, V _R = 25 V		-	462	-	ns
Reverse Recovery Charge	Q _{rr}			-	8.3	-	μC
Reverse Recovery Current	I _{RRM}			-	30	-	Α

Note

a. $C_{oss eff.}$ (TR) is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DS} .



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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



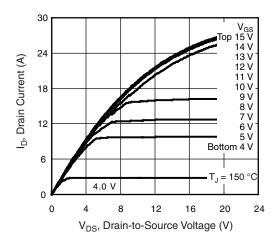


Fig. 2 - Typical Output Characteristics, T_J = 150 °C

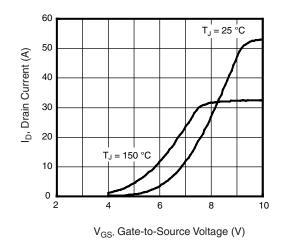


Fig. 3 - Typical Transfer Characteristics

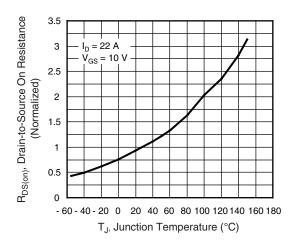


Fig. 4 - Normalized On-Resistance vs. Temperature

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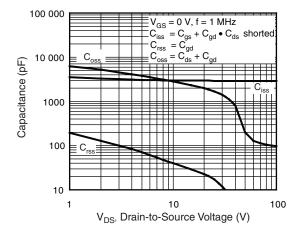


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

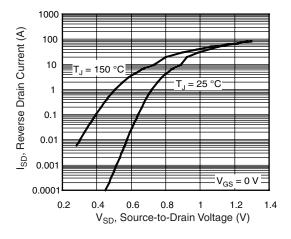


Fig. 7 - Typical Source-Drain Diode Forward Voltage

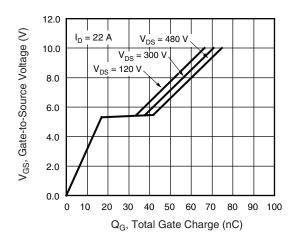


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

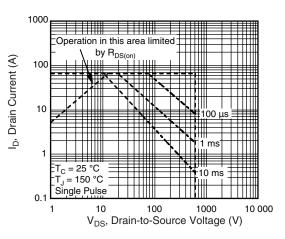
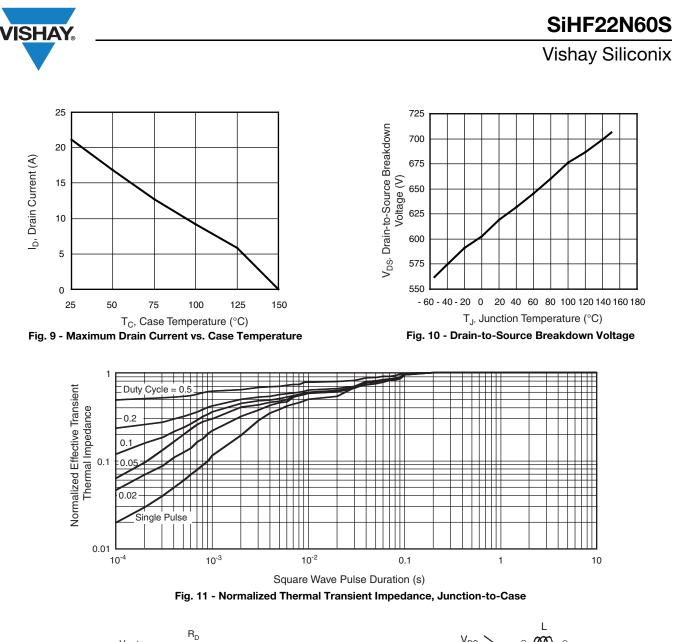


Fig. 8 - Maximum Safe Operating Area



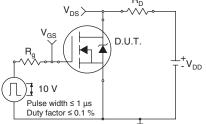


Fig. 11a - Switching Time Test Circuit

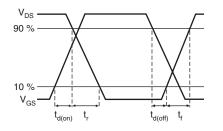


Fig. 11b - Switching Time Waveforms

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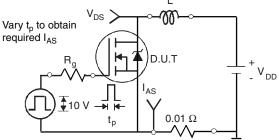


Fig. 12a - Unclamped Inductive Test Circuit

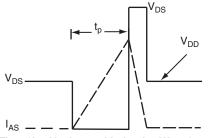


Fig. 12b - Unclamped Inductive Waveforms

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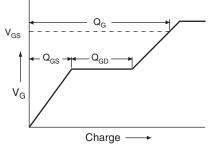


Fig. 13a - Basic Gate Charge Waveform

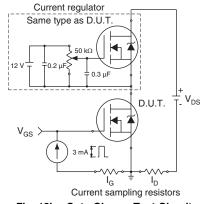


Fig. 13b - Gate Charge Test Circuit

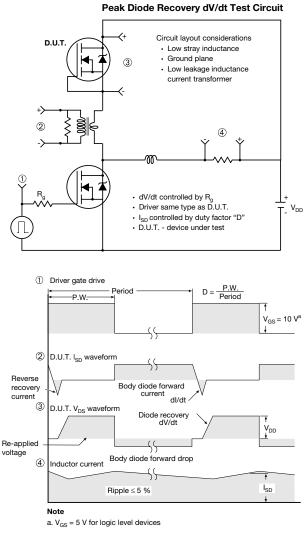


Fig. 14 - For N-Channel

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